Special Issue

Advanced 3D Bioprinting Technologies

Message from the Guest Editor

Three-dimensional bioprinting is a powerful technology which combines biomanufacturing with additional manufacturing. It provides a new method for the research of tissue engineering and regenerative medicine. To date, 3D bioprinting has made great progress in the fields of bioink preparation, printing process development, printing equipment development and medical application research. This Special Issue aims to collect important works addressing the bioprinting process, rebuilding tissue/organ functionalization in vitro, bioink design, printing of surgical instruments or prosthesis, etc.

Guest Editor

Prof. Dr. Yong He

Deputy Director, State Key Laboratory of Fluid Power and Mechatronic Systems, Zhejiang University, Hangzhou 310027, China

Deadline for manuscript submissions

closed (31 July 2021)



Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



mdpi.com/si/72664

Applied Sciences Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41 61 683 77 34 applsci@mdpi.com

mdpi.com/journal/applsci





Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multidimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility:

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, CAPlus / SciFinder, and other databases.

Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

